IMPORTANT DATES

April 29, 2019   Submission of abstracts ends
May 20, 2019   Notification of acceptance
June 3, 2019   Final program
September 5, 2019   Exhibitor registration ends
October 1, 2019   Registration ends
October 9–11, 2019   ISPA takes place

VENUE

Fraunhofer Institute for Ceramic Technologies and Systems IKTS
Winterbergstrasse 28
Dresden, Germany

CONTACT TO ORGANIZERS

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REGISTRATION FEES

Regular  Euro 395,-
Speaker   Euro 385,-
Reduced*   Euro 200,-
Exhibitors  Euro 895,- plus 19 % VAT

* Students with valid student card and one exhibitor second person qualify for the reduced registration fee.

REGISTRATION

Please register on our website: www.ikts.fraunhofer.de.
Registration is possible until October 1, 2019.
INVITATION

It is a great pleasure to invite you to the International Symposium on Piezocomposite Applications ISPA 2019, to be held in the scientific, economic and cultural center of Dresden, Germany from October 9 to 11, 2019.

The symposium will address scientific and technological developments related to piezoceramics and functional units to provide solutions for control and positioning tasks, measuring tasks, power supply, materials treatment, and ultrasound and vibration applications. This year, haptic solutions and medical applications will be highlighted. Current scientific and technological developments, commercial service offers and customer requirements are within the scope of the symposium.

The ISPA 2019 intends to serve as a platform and information interface enabling an exchange of information on market requirements, research interests and current results, skills and resources as well as facilitating the building of future partnerships. Engineers, designers and managers are invited to lecture on their state-of-the-art developments and future prospects or display their products and offers as exhibitors.

Together with the members of the scientific and organizing committees, we look forward to meeting you in Dresden.

Yours, Andreas Schönecker, Holger Neubert and Thomas Daue

CALL FOR PAPERS

The ISPA will include invited lecturers as well as papers by contributing authors. Authors of conference papers are kindly requested to submit an abstract by e-mail to ispa@ikts.fraunhofer.de no later than April 29, 2019. Abstracts will be reviewed by the conference organizers by May 20, 2019.

- Abstract with max. 250 words, pdf or word file
- Please underline the presenting author
- Please add address, phone number and e-mail address

TOPICS

- Piezoelectric materials and devices
- Solutions and custom requirements concerning
  - Control and positioning tasks
  - Measuring tasks
  - Decentralized power supply of devices
  - Materials treatment
  - Sound and vibration applications
- R&D services concerning Electronics
- Modeling, characterization, reliability
- Systems integration
- Market and future developments

INDUSTRIAL EXHIBITION

You are interested to present your company and products at this international event?

Offer for exhibitors

- Standard booth: ca. 5 m², including table, chair, poster board (A0), 240 V AC power supply
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